PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SAM S. KANG	01/24/2015
JOHN M. JORGENSEN	01/28/2015
BHARAT SHENOY	01/30/2015
KUNGHAO YU	02/03/2015

RECEIVING PARTY DATA

Name:	LITTELFUSE, INC.	
Street Address:	8755 WEST HIGGINS ROAD	
Internal Address:	SUITE 500	
City:	CHICAGO	
State/Country:	ILLINOIS	
Postal Code:	60631	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14593128

CORRESPONDENCE DATA

Fax Number: (919)999-2798

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Correspondent Name: KACVINSKY DAISAK BLUNI PLLC (1511)

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Address Line 2: SUITE 303

Address Line 4: LAWRENCEVILLE, NEW JERSEY 08648

ATTORNEY DOCKET NUMBER:	1511SI0965
NAME OF SUBMITTER:	DANIEL N. DAISAK
SIGNATURE:	/Daniel N. Daisak/
DATE SIGNED:	02/05/2015

Total Attachments: 2

PATENT REEL: 034908 FRAME: 0024 source=1511SI0965_Executed_Assignment#page1.tif source=1511SI0965_Executed_Assignment#page2.tif

PATENT REEL: 034908 FRAME: 0025 Docket No.: 1511S10965

PATENT

ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned:

SAM S. KANG JOHN M. JORGENSEN BHARAT SHENOY KUNOHAO YU

hereby sell, assign, and mansfel to:

LITTELFUSE, INC.

a corporation of <u>Delawars</u>, having a principal place of husiness at <u>8755 West Fliggins Road</u>, <u>Suite 500</u>, <u>Chicago</u>, <u>IL 60631</u>, ("Assignee"), and its successors, assigns and legal representatives, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements that are disclosed in the application for the United States patent entitled:

OVERCURRENT DETECTION OF LOAD CIRCUITS WITH TEMPERATURE COMPENSATION

which was filed on January 9, 2615 as U.S. Patent Application No. 14/593,128

which has been executed by the undersigned prior hereto or concurrently berewith on the date(s) indicated below,

and in and to said application and all divisional applications, continuation applications, continued prosecution applications, continuation-in-part applications, substitute applications, renewal applications, reissue applications, reexaminations, extensions, and all other patent applications that have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original patents, reissued patents, reexamination certificates, and extensions, that have been or shall be issued in the United States and all foreign countries on said improvements; and in and to all rights of priority resulting from the filing of said United States application,

agree that said Assignee may apply for and receive a patent or patents for said improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all divisional applications, continuation applications, continuations, continued prosecution applications, continuation-in-part applications, substitute applications, renewal applications, reissue applications, reexaminations, extensions and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and representatives all facts known to the undersigned relating to said improvements and the history thereof; and generally assist said Assignee.

PATENT REEL: 034908 FRAME: 0026 its successors, assigns, or representatives in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements, and all applications for patents and all prients on said improvements, in said Assignee, its successors, assigns, and legal tepresentatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, horise, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Please Sign and Date Bolow:

Assignment Document Return Address: KACVINSKY DAISAK STUNI PLLC 3120 Princeton Piko, Suito 303

Top Pax

919 636 4767 919 999 2798

Lawrenceville, NJ 08648

Ducker No.: 1811910968

PATENT REEL: 034908 FRAME: 0027

RECORDED: 02/05/2015